

Wall Industries, Inc.

LANC2415UW12

DC/DC Converter 9-36 VDC Input 15 VDC Output at 0.8A



Applications:

- Distributed Power Architectures
- Communications Equipment
- Computer Equipment
- Work Stations

Features:

- RoHS Compliant
- Single Output
- Standard 24 Pin DIP and SMT Package
- Five-Sided Continuous Shield
- No Minimum Load Required
- High Power Density
- High Efficiency up to 88%
- Small Size: 1.25 x 0.8 x 0.450 Inches
- Input to Output Isolation (1600VDC)
- 4:1 Ultra Wide Input Voltage Range
- Fixed Switching Frequency
- Input Under-Voltage Protection
- Output Over-Voltage Protection
- Over-Current Protection
- Output Short Circuit Protection
- Remote ON/OFF

Description:

The LANCUW12 single output series offers 12 watts of output power from a package in an IC compatible 24pin DIP and SMT configuration. LANCUW12 single output series has 4:1 wide input voltage of 9-36VDC and 18-75VDC. The LANCUW12 single output series features 1600VDC of isolation, short circuit protection and five sided shielding. All models are particularly suited for telecommunications, industrial, mobile telecom, and test equipment applications.

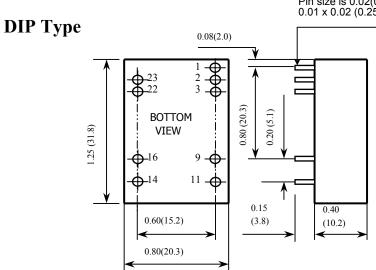


Technical Specifications	Model No. LANC2415U				
All specifications are based on 2	5 °C, Nominal Input Voltage and Maximum Output Current	unless oth	nerwise not	ted.	
SPECIFICATION We reserve th	ne right to change specifications based on technological adva Related condition	ances. Min	Nom	Max	Unit
Switching Frequency	Test at nominal Vin and full load	IVIIII	400	IVIAX	kHz
INPUT (V _{in})	Test at nonlinar vill and full foad		400		KIIZ
Operating Voltage Range		9	24	36	Vdc
Input Voltage (Continuous)		9	24	40	Vdc
Input Voltage (Transient 100ms)				50	Vdc
UVLO Turn-on Threshold			9	50	Vdc
UVLO Turn-off Threshold			8		Vdc
Input Standby Current	Nominal Vin and No Load		25		mA
Input Voltage Variation	Complies with EST300 132 part 4.4		25	5	V/ms
Input Current	Nominal Vin and Full Load			610	mA
Input Current	5 to 20MHz, 12μ H source impedance			010	IIIA
Reflected Ripple Current	(See the Test Setup section - pg 8)		20		mA _{pk-p}
	Test at nominal Vin and full load				
EFFICIENCY	(See the Test Setup section – pg 8)		86		%
	(See the Test Setup section – pg 8)				
OUTPUT (V ₀)	Nominal Vin and Full Load	14.00	15.0	15 10	Vdc
Operating Output Range	Nominal Vin and Full Load 0% to 100% Full Load	14.82	15.0	15.18 + 0.5	Vdc %
Load Regulation (DIP Type)		-0.5			
Load Regulation (SMT Type)	0% to 100% Full Load	-1.0		+1.0	%
Line Regulation	LL to HL at Full Load	-0.2		+0.2	%
Output Ripple & Noise	5Hz to 20MHz bandwidth			85	mV _{pk-p}
	(See the Test Setup section - pg 8)	0		0.0	
Output Current		0		0.8	A
Output Voltage Overshoot	LL to HL at Full Load		0	3	% Vout
Over Voltage Protection	Zener diode clamp		18		Vdc
Over Current Protection	· · · · · · · · · · ·		150		% FL
Short Circuit Protection		Conti	inuous, aut	omatic re	coverv
DYNAMIC LOAD RESPONSE	Test at nominal Vin				,
Peak Deviation	Load step change from 75 to 100% or 100 to 75 % of FL		200		mV
Setting Time (Vout < 10% peak deviation)	1 0		250		μs
REMOTE ON/OFF	The ON/OFF pin voltage is referenced to -Vin (See the Remote ON/OFF Control section - pg 5)				
ON/OFF pin High Voltage (Remote ON)	(bee the Remote $O(V)$ of V control section - $pg(S)$	3.0		12	Vdc
ON/OFF pin Low Voltage (Remote OFF)		0		1.2	Vdc
ON/OFF pin Low Voltage, input current		0		2.5	mA
START UP TIME	Test at nominal Vin and constant resistive load			2.5	1117 1
Power Up	Test at nominar vin and constant resistive foud		450		ms
Remote ON/OFF			5		ms
ISOLATION			5		1115
Isolation Voltage (Input-Output)		1600			Vdc
Isolation Voltage (Output to Case–DIP Type)		1600			Vdc
Isolation Voltage (Output to Case–Dh Type)		1000			Vdc
Isolation Voltage (Output to Case - DIP Type)		1600			Vdc
Isolation Voltage (Input to Case - SMT Type)		1000			Vdc
Isolation Resistance		1000			GΩ
		1		1500	
Isolation Capacitance				1500	pF
ENVIRONMENTAL Operating Ambient Temperature (w/ derating)		40		05	°C
		-40		85	°C
Operating Case Temperature		55		105	°C
Storage Temperature		-55		125	
Temperature Coefficient		-0.02		+0.02	% / °C
MTBF	See the MTBF and Reliability section (pg 13)		0.050.000		1
Bellcore TR-NWT-000332, $T_C=40^{\circ}C$			2,350,000		hours
MIL-STD-217F			875,000		hours
MECHANICAL			See Fi	gure 1	
Weight			18.0		grams
Dimensions		1.25	5 x 0.8 x 0.	450	inches

(888) 597-WALL



Figure 1: Mechanical Dimensions



Pin size is 0.02(0.5) Dia or 0.01 x 0.02 (0.25 x 0.50) Rectangular Pin

Table 1

I able I			
Pin Connection			
Pin	Define	Pin	Define
1	CTRL		
2	-Input	23	+Input
3	-Input	22	+Input
9	NC	16	-Output
11	NC	14	+Output

 All dimensions are in Inches (mm) Tolerance: x.xx±0.02 (x.x±0.5)
Pin pitch tolerance ±0.014(0.35)



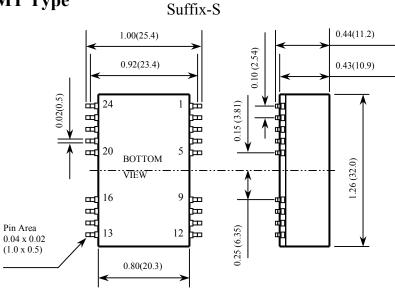


Table 2

Pin Connection				
Pin	Define	Pin	Define	
1	CTRL			
2	-Input	23	+Input	
3	-Input	22	+Input	
9	NC	16	-Output	
11	NC	14	+Output	
Others	NC	Others	NC	

1. All dimensions in Inches (mm)

Tolerance: x.xx±0.02 (x.x±0.5)

2. Pin pitch tolerance $\pm 0.014(0.35)$



DESIGN CONSIDERATIONS:

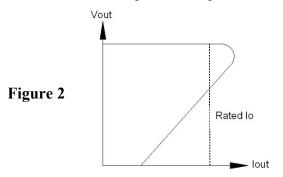
Output Over Current Protection

When excessive output currents occur in the system, circuit protection is required on all power supplies. Normally, overload current is maintained at approximately 150% of rated current for the LANCUW12 single output series.

Fold back-mode is a method of operation in a power supply whose purpose is to protect the power supply from being damaged during an over-current fault condition. It also enables the power supply to operate normally when the fault is removed.

One of the problems resulting from over current is that excessive heat may be generated in power devices; especially MOSFET and Schottky diodes and the temperature of those devices may exceed their specified limits. A protection mechanism has to be used to prevent those power devices from being damaged.

The operation of fold back is as follows. When the current sense circuit sees an over-current event, the output voltage of the module will be decreased for low power dissipation and decrease the heat of the module.



Output Over Voltage Protection

The output over-voltage protection consists of an output Zener diode that monitors the voltage on the output terminals. If the voltage on the output terminals exceeds the over-voltage protection threshold, then the Zener diode clamps the output voltage.

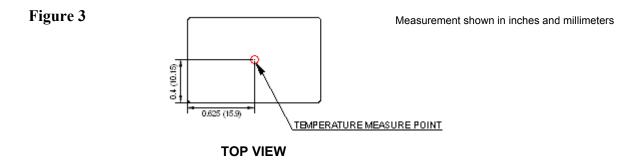
Input Source Impedance

The power module should be connected to a low impedance input source. Highly inductive source impedance can affect the stability of the power module. Input external L-C filter is recommended to minimize input reflected ripple current. The inductor is simulated source impedance of 12 μ H and capacitor is Nippon chemi-con KZE series 47 μ F/100V. The capacitor must as close as possible to the input terminals of the power module for lower impedance.



Thermal Consideration

The power module operates in a variety of thermal environments. However, sufficient cooling should be provided to help ensure reliable operation of the unit. Heat is removed by conduction, convention, and radiation to the surrounding environment. Proper cooling can be verified by measuring the point as the figure below. The temperature at this location should not exceed 105°C. When operating, adequate cooling must be provided to maintain the test point temperature at or below 105°C. Although the maximum point temperature of the power modules is 105°C, you can limit this temperature to a lower value for extremely high reliability.

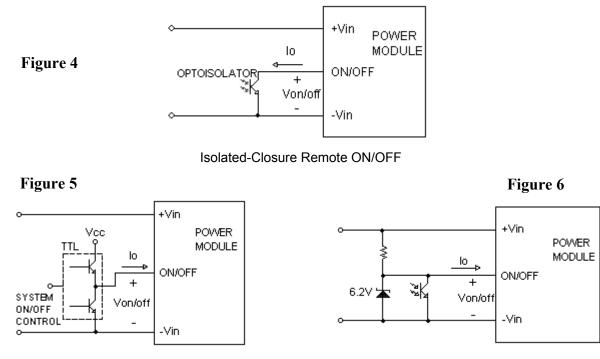


Remote ON/OFF Control

The positive logic remote ON/OFF control circuit is included.

Turns the module ON during a logic High on the On/Off pin and turns OFF during a logic Low. The On/Off pin is an open collector/drain logic input signal (Von/off) that's referenced to GND. If not using the Remote On/Off feature, please open circuit between on/off pin and –input pin to turn the module on.

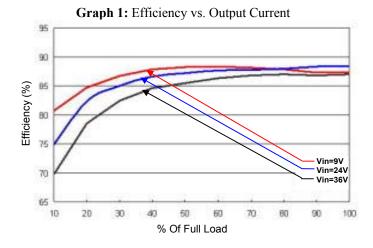
Remote ON/OFF Implementation



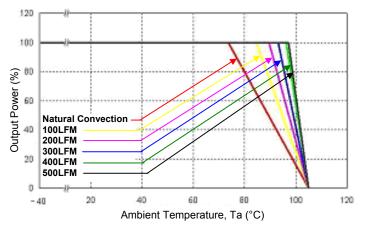
Level Control using TTL Output

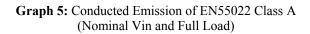
Level Control using Line Voltage

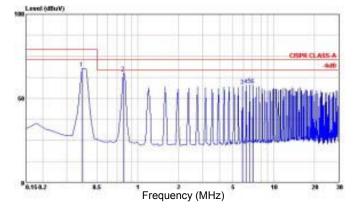


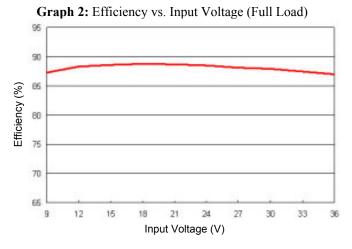


Graph 3: Output Power vs. Ambient Temperature & Airflow (Nominal Vin)

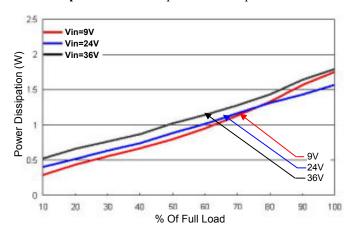




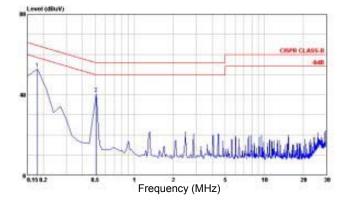




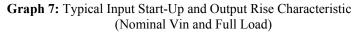
Graph 4: Power Dissipation Vs. Output Current

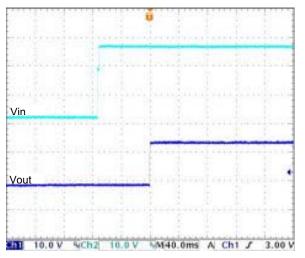


Graph 6: Conducted Emission of EN55022 Class B (Nominal Vin and Full Load)

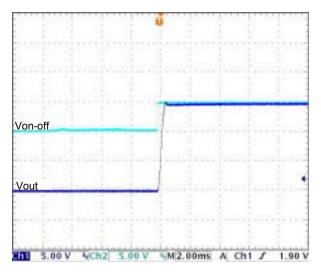


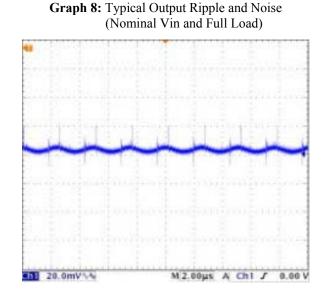




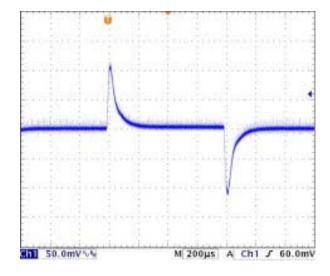


Graph 9: Using ON/OFF Voltage Start-Up and Vo Rise Characteristic (Nominal Vin and Full Load)





Graph 10: Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load at Nominal Vin

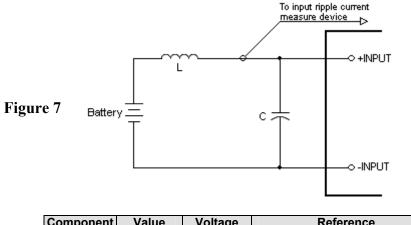




TEST SETUP:

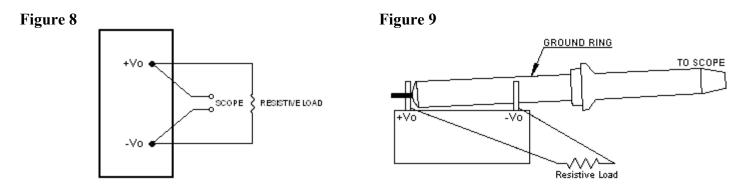
The LANC2415UW12 specifications are tested with the following configurations:

Input Reflected-Ripple Current Measurement Test Setup



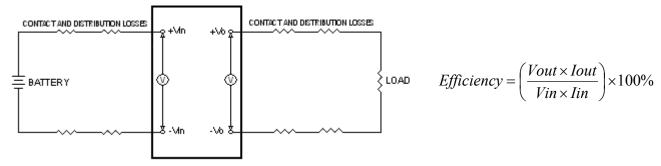
Component	Value	Voltage	Reference
L	12µH		
С	47µF	100V	Aluminum Electrolytic Capacitor

Peak-to-Peak Output Ripple & Noise Measurement Setup



Output Voltage and Efficiency Measurement Setup

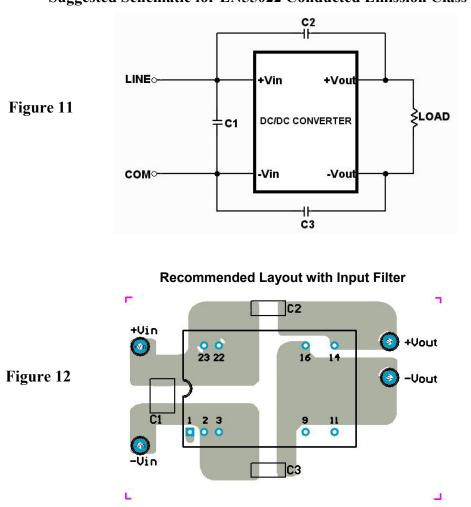
Figure 10



NOTE: All measurements are taken at the module terminals



EMC Considerations



Suggested Schematic for EN55022 Conducted Emission Class A Limits

To meet Conducted Emissions EN55022 CLASS A needed the following components:

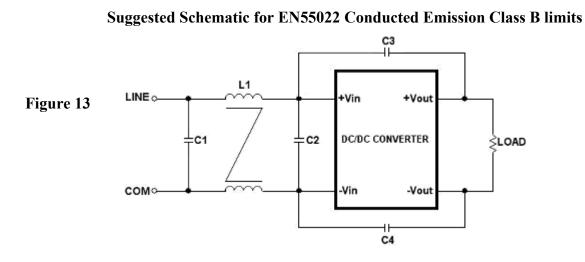
LANC24xxUW12				
Component	Value	Voltage	Reference	
C1	1uF	50V	1210 MLCC	
C2, C3	1000pF	2KV	1206 MLCC	

LANC48xxUW12

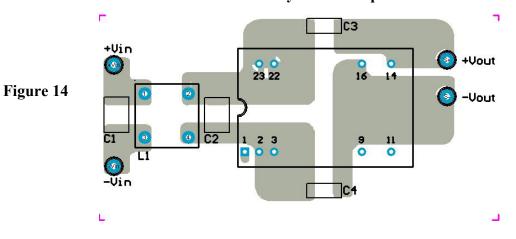
Component	Value	Voltage	Reference	
C1	0.47uF	100V	1812 MLCC	
C2, C3	1000pF	2KV	1206 MLCC	



EMC Considerations (Continued)



Recommended Layout with Input Filter



To meet Conducted Emissions EN55022 CLASS B needed the following components:

LANC24xxUW12				
Component	Value	Voltage	Reference	
C1	4.7µF	50V	1812 MLCC	
C3, C4	1000pF	2KV	1206 MLCC	
L1	325µH		Common Choke, P/N: PMT-050	

LANC48xxUW12

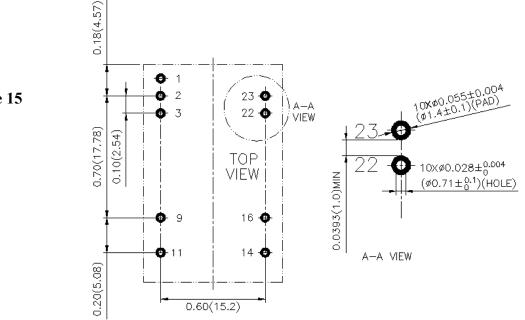
Component	Value	Voltage	Reference
C1	1.5µF	100V	1812 MLCC
C3, C4	1000pF	2KV	1206 MLCC
L1	325µH		Common Choke, P/N: PMT-050





Recommended Pad Layout for DIP Type

Figure 15



Recommended Pad Layout for SMT Type

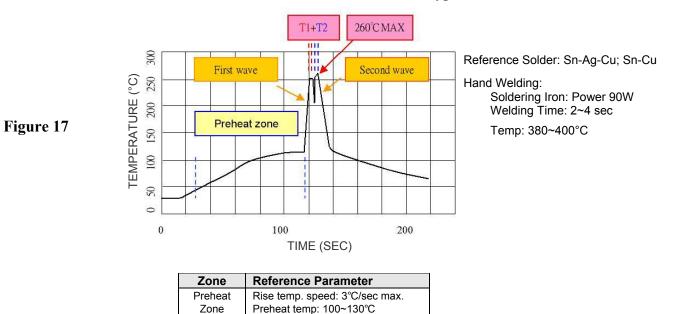
0.060(1.54) 0.485(12.32)0.485(12.32) 0.100(2.54) 1 24 0.150(3.81) Figure 16 TOP (9:220 9:320 0:320 0:320 0.079 (2.03) VIEW 0.100(2.54) 12 13 1.05(26.67)

- 1. All dimensions in Inches (mm)
- 2. Pin pitch tolerance ± 0.35 mm
- 3. Tolerance: x.xx±0.02 (x.x±0.5)

x.xxx±0.01 (x.xx±0.25)



Soldering and Reflow Considerations:

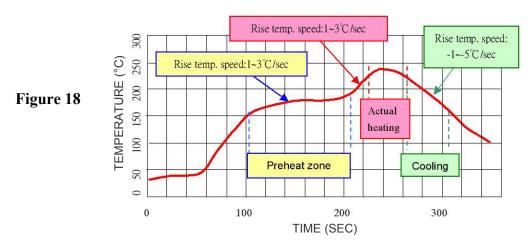


Lead Free Wave Solder Profile for DIP Type

Lead free reflow profile for SMT type

Peak temp: 250~260°C

Peak time (T1+T2 time): 4~6 sec



Actual

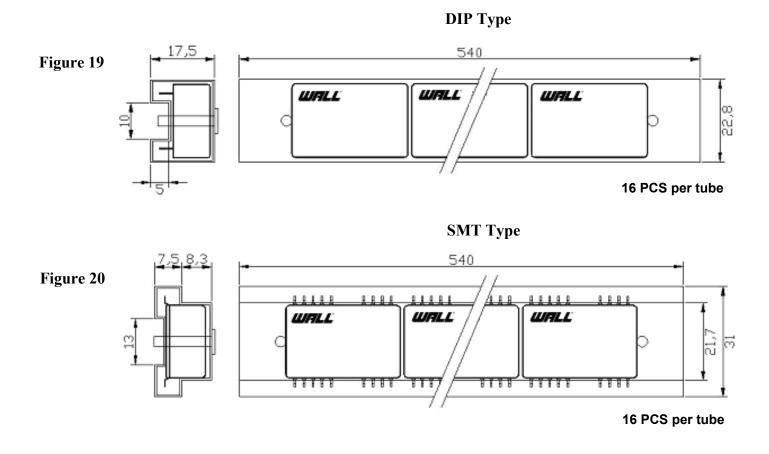
Heating

Zone	Reference Parameter
Preheat	Rise temp. speed: 1~3°C/sec
Zone	Preheat time: 60~120sec
20110	Preheat temp.155~185°C
	Rise temp. speed: 1~3°C/sec
Actual	Melting time: 30~60 sec
Heating	Melting temp: 217°C
rieating	Peak temp: 230~240°C
	Peak time: 10~20 sec
Cooling	Rise temp. speed: -1~ -5°C/sec

Reference Solder: Sn-Ag-Cu; Sn-Cu



Packaging Information:



Safety and Installation Instruction:

Fusing Consideration

Caution: This power module is not internally fused. An input line fuse must always be used.

This encapsulated power module can be used in a wide variety of applications, ranging from simple stand-alone operation to an integrated part of sophisticated power architecture. To maximum flexibility, internal fusing is not included; however, to achieve maximum safety and system protection, always use an input line fuse. The safety agencies require a normal-blow fuse with maximum rating of 3A. Based on the information provided in this data sheet on Inrush energy and maximum DC input current; the same type of fuse with lower rating can be used. Refer to the fuse manufacturer's data for further information.

MTBF and Reliability

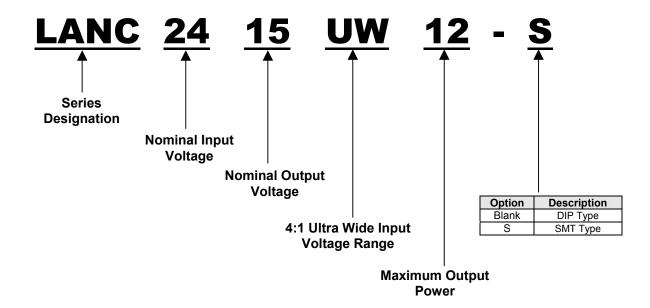
The MTBF of the LANCUW12 single output series of DC/DC converters has been calculated using Bellcore TR-NWT-000332 Case I: 50% stress, Operating Temperature at 40°C (Ground fixed and controlled environment). The resulting figure for MTBF is 2.35×10^6 hours.

MIL-HDBK 217F NOTICE2 FULL LOAD, Operating Temperature at 25°C. The resulting figure for MTBF is 8.745×10^6 hours.



Ordering Information:

Part Number Example:



Company Information:

Wall Industries, Inc. has created custom and modified units for over 40 years. Our in-house research and development engineers will provide a solution that exceeds your performance requirements on-time and on budget. Our ISO9001-2000 certification is just one example of our commitment to producing a high quality, well documented product for our customers.

Our past projects demonstrate our commitment to you, our customer. Wall Industries, Inc. has a reputation for working closely with its customers to ensure each solution meets or exceeds form, fit and function requirements. We will continue to provide ongoing support for your project above and beyond the design and production phases. Give us a call today to discuss your future projects.

Contact Wall Industries for further information:

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